

BoardMaster 5.1





Manual BoardMaster 5.1

English, Version 1.0

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Preface

This Manual introduces you to operation of *BoardMaster* 5.1 for *Win-dows*[™]. LPKF *BoardMaster* is a program for automatic control of HP-GL-compatible LPKF circuit board plotters.

LPKF *BoardMaster* is capable of reading in, displaying and processing production data in LMD format (generated in LPKF CircuitCAM) as well as production data generated in HP-GL format

BoardMaster takes over complete control of the circuit board plotter. The WYSIWYG (What You See Is What You Get) display for the data to be processed, manual control of the circuit board plotter on the *Windows* surface as well as the present tool library with all required information ensures virtually complete automation of circuit board prototype production.

This Manual describes the way from LMD/HP-GL circuit board data generated by *CircuitCAM* or other programs, over job preparation right up to completion of the circuit board prototypes with the circuit board plotter.

The Manual introduces the basic control possibilities of *BoardMaster* step by step, allowing you to quickly complete your first circuit board in a simple manner.



Notes on this manual

Basic use of the *Windows* surface is not covered in this Manual. If you are not familiar with use of the various *Windows* objects, please first refer to your *Windows* documentation.

I. Manual outline

This Manual is divided up into the following chapters:

- 1. Safety Instructions
- 2. Installation
- 3. Operating interface
- 4. Production process
- 5. Troubleshooting
- 6. Appendix

II. Conventions used in this manual

Bold text is used to emphasize important information.

Illustrations are numbered continuously - Example: Fig. 5.

Italic sections are used to indicate reactions resulting from an action.

Words printed in *italics* indicate proper names.

Key inscriptions and menu terms are printed in **BOLD CAPITALS**.



III. Notes on the symbols used



Danger!

This symbol is used to warn of danger to life or health..



Attention!

This symbol is used to identify hazards which may cause damage.

Note:

This symbol is used for notes intended to help you to avoid malfunctions in operation or help you to improve your procedures

IV. Legend

CircuitCAM	: Software used for data preparation
BoardMaster	: Software used for machine controlling
shearing winkel	: In the ideal case the angle between X aund Y- axis is 90 degrees. This results in a shearing angle of 0 degrees. The shearing angle is the rela- tion of the two axes with respect to each other.

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1 Safety precautions

Always observe the following points for your own safety. The use of *BoardMaster* <u>alone</u> represents only a minor hazard potential.

- Ensure that your computer is properly connected to the line power and to the circuit board plotter!
- Ensure that no one is present in the hazard area of the circuit board plotter during data transfer between *BoardMaster* and the circuit board plotter!
- Ensure that no one can enter the hazard area of the circuit board plotter and come into contact with the tools during operating phases controlled by *BoardMaster*!



- Ensure that it is not possible for unauthorized persons to operate *BoardMaster* when working with the circuit board plotter, for example during manual tool change or alignment of the base material!
- In the event of an emergency, shut off the circuit board plotter and PC connected to the circuit board plotter immediately!
- Always observe the safety precautions specified in the manual for the circuit board plotter!
- Also observe other safety precautions in this manual!



2 Installation

2.1 System prerequisites

The minimum system prerequisites for installation of *BoardMaster* are:

- Pentium Processor with 700 MHz or faster
- 128 MB RAM (main memory), 256 MB recommended
- XGA grafics card, screen resolution 1024 x 768 pixel recommended
- Operation System: Microsoft Windows 2000/XP
- min. 4x-speed CD ROM drive
- RS232 or USB interface depending on the LPKF ProtoMat type

BoardMaster requires approx. 16 MB of free hard disk capacity for installation.

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2.2 Scope of delivery

The BoardMaster scope of delivery includes:

- 1 x CD ROM with *BoardMaster* programm
- 1 x BoardMaster manual



2.3 Installation

- Insert the BoardMaster ... & CircuitCAM ... CD into the CD-Drive and wait until the welcome Window "Rapid Prototyping PCB" will be openend. Depending on the computer this can last up to one or two minutes.
- > If the welcome window "Rapid Prototyping PCB" is not opened automatically: Start the **setup.exe** file on the CD.

The window BoardMaster 5.1 InstallShield Wizard will be opened:

Existing Installed Instances Detected Select the appropriate application instance to maintain or update. Select the appropriate application instance to maintain or update an existing instance of this application already installed on your system. You can maintain or update an existing instance of this application selected below: Install a new instance of this application Maintain or update the instance of this application selected below: Display Name Install Location BoardMaster 5.1.203 C:\Program Files\LPKF Laser & Electronics\BoardMaster 5.1.201 Install Completely new instance of the application already installed on your system. You can maintain or update the instance of this application selected below: Display Name Install Location BoardMaster 5.1.203 C:\Program Files\LPKF Laser & Electronics\BoardMaster 5.1.201 InstallShield <</td> Back Next> Cancel InstallShield Back Next> Cancel

- > Select the radio button "Install an new version of this product".
- > Click on NEXT.

Note: For updating an existing software version select the radio button "Update selected product shown in the list below". Define the path to the programm folder and click on **NEXT**.

Fig. 1: Installation window





> Select the desired language (English or German).

Note: The selected language is just for the installation process. The language used for the software to be installed must be select later.

> Click on NEXT.

The following window will be shown:



> Click on NEXT.

Fig. 3: Start of installation

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Fig. 4: Program language selection

Select the setup type that best suits your needs.	tup Туре		
 English Deutsch Frensh Japanese Spanish 	elect the setup type that best s	ts your needs.	
 English Deutsch Frensh Japanese Spanish 			
 English Deutsch Frensh Japanese Spanish 			
 English Deutsch Frensh Japanese Spanish 			
 English Deutsch Frensh Japanese Spanish 			
 English Deutsch Frensh Japanese Spanish 			
 Deutsch Frensh Japanese Spanish 		💿 English	
 Deutsch Frensh Japanese Spanish 			
 Frensh Japanese Spanish 		💭 Deutsch	
 Frensh Japanese Spanish 			
 Japanese Spanish 		💭 Frensh	
© Japanese ♥ Spanish			
C Spanish		💭 Japanese	
Spanish University Spanish			
		U Spanish	

- > Select the language for the *BoardMaster 5.1* operating interface.
- Click on the radio button for the choosen language, for example English.
- > Click on NEXT.
- > The following window will be schown:

The following window will be shown:

BoardMaster 5.1.203 - InstallShield Wi Choose Destination Location Select folder where setup will install files.	izard	
	Install BoardMaster 5.1.203 to: C:\\BoardMaster 5.1.203	Change
Install Shield	< Back	Cancel

> Click on NEXT.

Note: The Install Wizard use a defined destination folder for installation. Click button **CHANGE** to change the destination folder.

Fig. 5: Installation folder selection



The following window will be shown:

- BoardMaster 5,1,203 InstallShield Wizard

 Ready to Install the Program

 The wizard is ready to begin installation.

 Image: Click Install to begin the installation.

 If you want to review or change any of your installation settings, click Back. Click Cancel to exit the wizard.

 Image: Click Install Click Install to begin the installation settings, click Back. Click Cancel to exit the wizard.

 Image: Click Install Install Click Install Install
 - > Click on Install.
 - [] The BoardMaster installation will be finished automatically.

2.4 Start BoardMaster

After installation of *BoardMaster*, the Start menu contains a new program group "LPKF Laser & Electronics", as well as a new linkage on your *Windows* desktop.

For error-free operation with your circuit board plotter, it is absolutely necessary to observe the switch-on sequence specified below:

- Switch on the circuit board plotter.
- Wait until the green operating indicator on front or on the "data"-LED on the back panel of the circuit board plotter lights up.
- Start BoardMaster.

Otherwise, the communication accomplished even when *BoardMaster* is starting, cannot be performed.

2.4.1 Startup the program



- > Double-click on the *BoardMaster* icon on the desktop.
- Or click on Start > Programme > LPKF Laser & Electronics AG> BoardMaster

The BoardMaster startup window will be opened.

Fig. 6: Installation process



Fig 7: Startup screen



This startup screen may be visible for up to 8 seconds, which is related to the communication between the PC and the machine, it does not represent an error. After that, the program start is automatically continued.

- > In case of appearing the Connection... windows:
 - Check the operating state of the circuit board plotter and connection cable between PC and circuit borad plotter.
 - Check the connection settings (see chapter 3.1.4.6 "Connect" on page 40)
- > In case of appearing the **Tool status** windows:
 - Select the tool position and click on OK.

Fig 8: Startup screen



[] The BoardMaster operation interface will be opened.



3 Operation interface



The figure shows the *BoardMaster* operation interface:

- 1- title bar
- 2- menu bar
- 3- function bar
- 4- tool change position (optional, only *ProtoMat* S62/S100)

5- available workspace

6- blue crosslines indicates the actual position of the drill / mill head

7- camera window (optional, *ProtoMat* with camera system)

The BoardMaster operation interface is separate in several areas:

- The **title bar** indicates the program name with the declaration of the circuit board plotter type as well as the name of an loaded or new created job.
- The menu bar indicates the available menu functions.
- The **function bar** contains several bottons, displays and functions to control the circuit board plotter and to modify a job.
- The **workspace** indicates graphically the topview on the circuit board plotter.
 - This area is itself divided up into the actual **motion range** of the circuit board plotter (displayed in dark gray) and the area of the **base material** used (displayed in green) with the **circuit board data** to be processed. **Only in this area**

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you can lower the head, therefore all data must be placed in this area.

You can adapt the graphic display of the working area to your specific requirements with the functions in the **VIEW** menu.

- The **display scroll bars** are located on the right of and below the working area and serve for moving the visible section into the working area.
- The current **mouse cursor position** is indicated at the left next to the horizontal scroll bar.
- The **status bar** below the horizontal scroll bar provides information on buttons, displays or areas where the mouse cursor is presently located.
- The **tool changing position** (for S62/S100) represents the stations 1-10 of the tool magazine.



3.1 Menu bar

The folloowing figure indicates the *BoardMaster* menu bar:

Fig 10: Menu bar



3.1.1 File menu

The functions of the **FILE** menu are used for file organisation and to close the *BoardMaster* program.

Fig 11: File menu

1- File menu

2- Edit menu

3- View menu

File	Edit	View	Configuration	Go to	Help
N	ew				
0	pen				
S	ave				
S	ave As				
Ir	nport				
R	efresh				
E	xit				
1	<star< td=""><td>ndard></td><td></td><td></td><td></td></star<>	ndard>			
2	c:\pro	ogramm	e\lpkf laser elec	tronics)	boardmaster\data\rr.job
3	c:\pro	ogramm	e\lpkf laser elec	tronics	boardmaster\data\ttt.job

NEW	Use this submenu to create a new job file for a <i>BoardMaster</i> application.
OPEN	Use this submenu to open an existing job file- for the a <i>BoardMaster</i> application.
SAVE	Use this submenu to save a <i>BoardMaster</i> job file. The file name will be the same as displayed in the title bar.
SAVE AS	Use this submenu to save a <i>BoardMaster</i> job file under a new file name.
IMPORT	Use this submenu to import production data or project files into the <i>BoardMaster</i> program.
ACTUAL	Use this submenu point to refresh the actual job file.
EXIT	Use this submenu point to close the <i>BoardMaster</i> program.



Fig 12: Import menu

3.1.1.1 Import data

Use the menu IMPORT to load production data or BoardMaster projects:

File		•		
Open				
Save				
Save As				
Import		×	LMD / LPR	1.
Refresh			HPGL into	New LPR
Exit				
1 <standard< th=""><th>></th><th></th><th></th><th></th></standard<>	>			
2 c:\program	nme\lpkf laser_electronics\boardmaster	\data\rr.job		
		in more		
3 c:\program	Select this entry	y to impor	t LMD file	es (Circuit
3 c:\program	Select this entry production data GL projects) int	y to impor) or LPR o <i>BoardM</i>	t LMD file files (<i>Boa</i> laster.	es (Circuit ardMaster
3 c:\program .MD/LPR IP-GL into	Select this entry production data GL projects) int In this subment	y to impoi) or LPR o <i>BoardI</i> ı, select t	rt LMD file files (<i>Boa</i> laster. he entry:	es (Circuit ardMaster
3 c:\program	Select this entry production data GL projects) int In this subment New LPR	y to impor) or LPR o <i>BoardM</i> J, select t to imp <i>Board</i>	t LMD file files (<i>Boa</i> <i>laster</i> . he entry: port the H <i>lMaster</i> a	es (<i>Circuit</i> ardMaster IP-GL files ind assign
3 c:\program	Select this entry production data GL projects) int In this subment New LPR	y to impor) or LPR o <i>BoardM</i> J, select t to imp <i>Board</i> to a n	t LMD file files (<i>Boa</i> <i>laster</i> . he entry: bort the H <i>lMaster</i> a ew projec	es (<i>Circuit</i> ardMaster IP-GL files ind assign ct.
3 c:\program	Select this entry production data GL projects) int In this subment New LPR STANDARD	y to impor) or LPR o <i>BoardM</i> u, select t to imp <i>Board</i> to a n to imp <i>Board</i>	t LMD file files (<i>Boa</i> <i>laster.</i> he entry: port the H <i>Master</i> a ew projec port HP-G	es (<i>Circuit</i> ardMaster IP-GL files and assign ct. GL files into assign

Note: Version 3.x LMD files can also be imported. However, it is necessary to reassign the tools "Assigning Tools" on page 85 and the production phases, because these names are not identical and *BoardMaster* cannot find the old names.

After importing LMD files, data is positioned immediately in the middle of the working area for the circuit board plotter. Moreover, the production data and the required tools are automatically assigned to the data: If it is not possible for *BoardMaster* to assign one or more tools, the following message appears:

Fig 13: Import message

Import	
At least one tool not assigned ! En	er the Edit Tool Assignment dialog box to complete assignment !
	ОК

In this case, it is necessary to assign the tools manually in the tool assignment dialog box or to complete the tool library before importing the data again.

After exporting the files, all tools required are listed in the *CircuitCAM* report window.



3.1.2 Edit menu

Fig 14: Edit menu

All function of the EDIT menu are used to overwork the proc	ess file.
---	-----------

Edit	
Placement	
Reload	
Check drill	
Teach In	
Tool Selection	
Tool Assignment	

PLACEMENT	Select submenu PLACEMENT to place new project on the basic material.
RELOAD	Select submenu RELOAD to overwork already manufactured circuit boards.
CHECK DRILLL	Select submenu CHECK DRILL to monitor the tool during the production process.
TEACH-IN	Select TEACH-IN to edit a production process step by step in <i>BoardMaster</i> .
TOOL SELECTION	not supported
TOOL ASSIGMENT	Select submenu TOOL ASSIGMENT to assign the tool to every project seperately.

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3.1.2.1 Placement menu

After you have imported or generated the required projects, you can place them in the *BoardMaster* working area. Imported projects are automatically positioned in the center of the working area or the predefined base material.

Click on **EDIT>PLACEMENT** to open the following submenu:

Fig 15: Placement menu

Placement			
TUTOR.LMD,(372.060,280.950),1×	Project. TOTOR.LMD	Scala	ок
	X 372.06 Y 280.95	1 Rotation [°]	Cancel
	Displacement [mm]	Count	Add
	× 57.89	1	Delete
	Y 40.11	1	Center
	× 57.89 Y 40.11	1 1	Delete Center

Place a project:

Click on ADD and select a project from the list. or:

Select a project from the list of the left side of the window to change the placement.

> Edit the text field SCALE to get the required scaling for the project.

Standard scale value is 1, indicating scale 1:1.

For application such as front plate and plate engraving other scales can be defined.

Enter the desired position for the project in the working area in the text field X and Y under ORIGIN. These values refer to the HOME position for the circuit board plotter and the data origin.

If the exact position of the data in the coordinate system are not known, enter the value 0 and 0 here and position the project in the working area with the aid of the function bar or computer mouse.

- Select the appropriate offset for the project in the working area under ROTATION.
- > To complete more than one prototype for a project, define the number of multiple boards under COUNT. Enter the number of boards in the X direction in the first text field and the number of boards in the Y direction in the second text field.



Enter the interval of the boards under DISPLACEMENT. Enter the displacement of the boards in the X direction in the first text field and the displacement of the boards in the Y direction in the second text field.

The displacement of the boards in relation to one another must correspond to at least the length and width of the circuit boards, because otherwise, the boards would overlap.

Multiple boards can also be created with the function bar.

Place a project in the base material center:

- > Select the corresponding project in the list field.
- > Click on **CENTER** to position the selected project in the center of the base material.

Add further project for placing:

- > Click on ADD.
- Select a project form the list for placing on the base base material additional.

Fig 16: Dialog box select project

Select Project	
TUTOR.LMD	
1	
ОК	Cancel

> Click on **OK** to close the dialog box.

Delete a placed project

Select the project with must be removed from the list.
 Click on CANCEL to remove the placed project from the base material.



3.1.2.2 Reload material menu

The function **RELOAD MATRIAL** serves for reloading a circuit board which has already been completed and cut, in order to drill additional holes, engrave text or separate the conductors for coding.

The prerequisites for using the reload function include a circuit board requiring reprocessing and the circuit board data as LMD file with at least two identifiable points (holes, reference marks, vectors), which can be assigned to the corresponding points on the circuit board.

The main purpose of the reload feature is to position the data so that it coincides with the circuit board to be processed. For this purpose, two identifiable points in the data (reference points) are assigned to the corresponding points on the circuit board to be processed.

When **RELOAD MATERIAL** is selected, the floating dialog box is opened:

Fig 17: Dialog box reload material

Reload Material		
① 1.point	ОК	
C 2.point	Cancel	
C 3.point		
C 4.point	Clear	
Settings	Read	
🗖 Enable	Move	

Reload material

- If not already accomplished, open the RELOAD MATERIAL dialog box. Click on the radio button for 1.POINT and select the first reference point on the data (center point of solder eye or hole, corner point).
- Click on to bring CENTER or EDGE mark to the required position.



Only drill hole selection



Move the machining head with tool installed or the cross hairs on the camera (LPKF CircuitView Option) as exactly as possible to the appropriate point on the circuit board. For this purpose, use the motion keys on the function strip:



> Click on the **READ** button to import the point.



- Actived radio button 2. PIONT and repeat the above desribed procedure for the second reference point (3. POINT and 4. POINT).
- > Mark the check box ENABLE.
- Close the dialog box RELOAD MATERIAL by clicking OK. A data reload will be activated.
- Mark all data to be transmited to the circuit board plotter. Th data will be recalculated acc. to the position on the printed circuit board after clicking START button.

To avoid the data adjustment of further jobs deactived the check box **SETTINGS**. Click on **OK** to leave the function and close the dialog box.

3.1.2.3 Drill break control

Click on **EDIT>BROKEN DRILL TOOL DETECTION** to open the following dialog box:

Fig 18: Dialog box Check drill

Broken drill tool detection	
Statisch Drill control before each tool change	
Drill control after drilling process	
200	
🗖 Confirm without measuring	
🗖 Confirm measuring	
	ОК
Check for broken tool	Cancel

If you activated the check box CHECK FOR BROKEN TOOL the following check functions are available:

Drill control before each tool change Drill control after drilling process	Click this check box to activate the broken drill tool detection before every tool change. Click this check box to activate the broken drill tool detection after a number of drills, defined in the input field below.
Confirm without measuring	Click this check box to drill a test hole automa- tically via <i>BoardMaster</i> . <i>BoardMaster</i> compare the hole dimension with the default parameter. If the hole dimension miss the default parame- ter <i>BoardMaster</i> generates a error message and the tool must be changed.
Confirm measuring	Click this check box to drill a test hole. The user must check the hole dimension and must confirm the correct hole dimension.
Check for brocken tool	Click this check box to activate the broken tool check.

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> Select the required function for broken tool check and click on OK.



Note: The functions described above are only for *ProtoMat* types with camera option.

3.1.2.4 Teach-In

The *BoardMaster* program offer the possibility of programming drilling and milling data from a template (film or circuit board) with the aid of a Teach-In process. For this purpose, fasten the template to the circuit board plotter and move to the individual positions to be programmed with the aid of the camera image in LPKF *CircuitView* (option). The HP-GL file completed in this manner can be read into *BoardMaster* after programming and output to the circuit board plotter.

Click on **EDIT>TEACH-IN** to open the following dialog box:

Fig 19: Dialog box Teach-In



STEP [MM]	The values entered under X and Y [mm] indi- cates the distance moved when the motion buttons (+X, -X, +Y and -Y) are pressed once.
	To program the drill holes in an IC enter a value of 2.54 mm here. This corresponds to a pad interval of 1/10".
HEAD	can be programmed by clicking one of the two radio buttons (UP, DOWN). The head remains in the selected position until the other radio button is activated.
	This function is not used to create a drilling file, but only for programming milling or contour data.
RECORD MOVE- MENTS	All movement command are stored in the sel- ected file when this check box is activated.
+X, -X, +Y, -Y Buttons	These buttons serve for moving to a desired position. If one of these buttons is clicked, the machining head moves in the selected direction by the value entered under STEP .



PEN	The pin number entered in this editing field is written to the selected file as the SELECT PEN command. This allows all drilling data even with different diameters to be combined in one drilling file. Example: Pin 1 for 0.7 mm, pin 2 for 0.9 mm and so on.
EXIT	Clicking this button discontinues the Teach-In process and closes the recorded drilling or mil- ling file.
CREATE FILE	By clicking this button <i>BoardMaster</i> requests entry of the name of a file in which the data to be programmed are to be stored. Here, it is possible to either create a new file or to write over a file already present.
APPEND FILE	Click this button to select a drilling or milling file which already exists to which the additional drilling or milling data are to be appended. The new data are appended at the end of the selec- ted file.
PEN [SP]	The pin or tool number selected under PEN is added to the drilling or milling file as the SEL- ECT PEN (SP) command when this button is clicked. It serves for differentiation of the indivi- dual drill diameters.
PLOT [PA]	Click this button to move the head (when RECORD MOVEMENT is switched off) at angles not equal to 90°.
DRILL [PD;PU;]	Click this button to program a hole at a position moved to previously. This causes the com- mand sequence PEN down, PEN up to be writ- ten into the file. This command chain

> Fasten the template (film or circuit board) on the circuit board plotter as parallel as possible to the axis.

corresponds to a drilling command for the cir-

> Click on EDIT>TEACH-IN to open the dialog box.

cuit board plotter.

> Click the **SAVE** button to create a file in which the data is to be stored. Enter a name for the file.

After you have entered the corresponding name, the **TEACH-IN** dialog box reappears.

Switch on the option RECORD MOVEMENTS, before starting the reading operation.

The file to be created is an HPGL file meaning that it is also written according to the steam for an HPGL file.

- First enter the desired pin number under PIN and then click the PEN (SP) button.
- > Then move with the aid of the motion keys (+X, -X, +Y, -Y) to the hole positions to be read in and press the DRILL (PD;PU) button.
- After reading in all of the required holes, the data is stored automatically, you can exit the **TEACH-IN** dialog box by pressing the **EXIT** button.

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The recorded coordinates are then available in the HPGL file created previously.

- Now select IMPORT>HPGL TO>NEW LPR... in the file menu, select the HP-GL file just created and enter a name for the new LPR project.
- > To produce something with this newly created file using *BoardMaster* and the machine, open the EDIT PROJECT dialog box to assign all required product phases and tools to the HP-GL file.

Moreover, set the unit corresponding to the machine resolution (e.g. 0.0079375) in the **EDIT PROJECT** dialog box (this value is also given in the settings **SETTINGS** dialog box in the **CONFIGURATION** menu).



Note: Please do not forget to reset the unit back to the original value after completion of this operation.



3.1.2.5 Tool assigment

Every *BoardMaster* job consist of one or more projects. A project is general definded as a printed circuit board imported as LMD file or HP GL project.

Click on EDIT>TOOL ASSIGMENT to open the following dialog box:

Abbildung 20:	Dialog box tool
assig	ment

TUTOR.LMD	Laser Create project		ОК
	Add project		Cancel
	Save as	Unit (mm):	
	Remove proj.	0.0001	
Phase File / Layer	File / Layer		
l l insulate i op	▲	-	
(1) Insulate lop (10) DrillPlated (11) DrillPlated (12) CuttingOutside	Phase	□ y => -y F	Pen 0.20 M ▼
(1) Insulate lop (10) DrillPlated (11) DrillPlated (12) CuttingOutside (16) DrillPlated (2) BoardOutline	Phase	「 y => -y F	Pen I 0.20 M 💌

Generally the production data will be imported via the file menu. Projects like LMD data from *CircuitCAM* or HP GL files can also added via this dialog box.

The LMD files generated during export in *CircuitCAM* contain the production data for the entire circuit board. The LMD files imported into *BoardMaster* are listed in the project list. The *CircuitCAM* layers with their production phases (phase) are listed in the field Phase file/Layer. Each of these entries contains one or more pieces of tool information (pins) with the assigned tools from the *BoardMaster* tool library (tool).

If automatic tool assignment was not possible (see above), it is necessary to edit the tools manual:

- > Select a LAYER without tool assignent from the list.
- Open the Pin list field and check whether a tool is assigned to each "PEN".
- > If not, select the tool to be used here from the Tool list field.

Repeat this assignent process until all tools are correct assigned.



3.1.3 View menu

To adapt the graphic display of the *BoardMaster* working area to the specific requirements of the user the functions in the **VIEW** menu can be used:

Fig 21: View menu		
	View	
	Zoom Area	
	Zoom In 1.5x	
	Zoom Out 1.5x	
	Machine	
	Material	
	All projects	
	Previous	
	Both sides	
	Real tools	
	✓ Default Font	
	Change Font	
	COM Report	
	Camera	
ZOOM AREA	Select submenu ZOOM AREA to display a fre- ely selectable cutout of the working area to fill the screen. For this purpose, press the left-mouse button and hold down while moving the mouse to define the desired area. You can also select	
	this function by clicking an the function bar.	
ZOOM IN X1.5	Select submenu ZOOM IN X1.5 to increase the graphic display by a factor of 1.5.	
ZOOM OUT /1.5	Select submenu ZOOM OUT /1.5 to decrease the graphic display by a factor of 1.5.	
MACHINE	Select submenu MACHINE to display the entire working surface of the circuit board plotter in the working area.	
MATERIAL	Select submenu MATERIAL to display the entire base material surface in the working area.	
ALL PROJECTS	Select submenu ALL PROJECTS to display all positioned projects as large as possible in the working area.	
PREVIOUS	Select submenu PREVIOUS to return to the previous screen display.	
BOTH SITES	Select submenu BOTH SITES to change back and forth between simultaneous display of both sides of the circuit board and display of only one side of the circuit board.	



REAL TOOLS	Select submenu REAL TOOLS switch display of the milled lines in the actual width ON and OFF. The actual width of the milled lines is defi- ned in the tool library.
DEFAULT FONT	Select submenu DEFAULT FONT to change back and forth between the <i>Windows</i> system font and the font set under CHANGE FONT for display of the text.
CHANGE FONT	Select submenu CHANGE FONT to select the font to be displayed when the DEFAULT FONT is deactivated.
COM REPORT	Select submenu COM REPORT to save the interface communication between computer and circuit board plotter (<i>ProtoMat</i>) in a log file.
CAMERA	Select submenu CAMERA to activate the camera (optional).

3.1.4 Configuration menu

All configuration settings with are used for *BoardMaster* or the connected circuit board plotter are grouped under this menu point:

Fig 22: Configuration menu

Configuration	
Material	►
Settings	
Tool Library	►
Heads	
Vacuum system	
Connect	
Tool box	
Phases	
Define Exchange Position	
Fiducial Settings	

MATERIAL	Select submenu MATERIAL to edit the material dimension.
SETTINGS	Select submenu SETTINGS to change or edit general process parameter.
TOOL LIBRARY	Select submenu TOOL LIBARAY to edit the tool library.
HEADS	Select submenu HEADS to open the head dialog box.
VACUUM SYSTEM	Select submenu VACUUM SYSTEM to open the exhausting dialog box.
CONNECT	Select submenu CONNECT to open the inter- face dialog box.

TOOL BOX	Select submenu TOOL BOX to open the WZ magazin dialog box.
PHASES	Select submenu PHASE to open the phase dialog box.
DEFINE EXCHANGE POSI- TION (<i>ProtoMat S42</i> only)	Select submenu DEFINE EXCHANGE POSI- TION to open the position read dialog box.
FIDUCAL SET- TINGS	Select submeu FIDUCAL to open the fiducal dialog box.

3.1.4.1 Material

By preparation of a new job first of all the size of the base material must be defined. It is necessary because BordMaster must display the actual work space inside the work area to support the optimal placing of the circuit board data.

Click on **CONFIGURATION>MATERIAL** to open the following submenu selection:

Fig 23: submenu selection material

Configuration		
Material		Size
Settings		Set Low Corner
Tool Library	Þ	Set High Corner
Heads	1	
Vacuum system		
Connect		
Tool box		
Phases		
Define Exchange Position		
Fiducial Settings		

This submenu provides two options to define the material size:

- use **SET LOW CORNER/HIGH CORNER** to edit the material size via moving the drill/mill head and reading the coordinates.
- use dialog box **SIZE** to edit the material size manual.

Size definition via moving drill/mill head:

Precise determination of the base material size can be accomplished with the circuit board plotter connected with the functions **SET LOW CORNER** and **SET HIGH CORNER** in the submenu **MATERIAL** in the menu **CONFIGURATION**.



Danger! The following instructions starts the circuit board plotter.

Ensure that no one can enter the motion range of the circuit board plotter. Danger of pinching and crushing!

Also observe the safety precautions in the circuit board plotter manual!



> Move the drill/mill head of the circuit board plotter with the arrow

keys 🗘 🗢 🗢 to the "front right corner" (X/Y-Min) on the circuit board material.

- > Click on CONFIGURATION>MATERIAL>SET LOW CORNER.
- > Move the drill/mill head of the circuit board plotter with the arrow
 - keys 🗘 🗢 🔍 to the "rear left corner" (X/Y-Max) on the circuit board material.
- > Click on CONFIGURATION>MATERIAL>SET HIGH CORNER.

After the base material size has been defined, it is displayed in dark gray in the *BoardMaster* working area.

Note: Always observe the specified sequence for setting the coordinates (first front right corner, then rear left corner)!

When defining the material size, observe attachment strips and the size of the working depth limitation as well as the position of the reference hole pins.

When a new job is defined; the already defined material size is deleted.

Manual input of the material size:



Note: This possibility for defining the size should only be used for preparing a job when the circuit board is not connected, because precise entry in consideration of the positioning on the circuit board plotter and the position of the reference holes in the base material is not possible.

Click on **CONFIGURATION>MATERIAL>SIZE** to open the following dialog box:

Fig 24: Dialog box material size

Define material	size and position	
	X [mm]	Y [mm]
Low corner	0	0
High corner	0	0
Size	0	0
	Reversed	
depender	nt on ProtoMat	
	ОК	Cancel



Note: The dialog box is splitted in two parts. The upper part is identically for all *ProtoMat* types and is use for the input of the base



material size. The lower part is depending on the actual *ProtoMat* type and is used for the input of informations like material thickness or free moving high. For more detail information take a look into the respective machine manual.

The size of the base material can be defined by manually entering the corresponding values in the text fields. The size calculated from the values in the upper text fields is displayed in the text field **SIZE**.

After exiting this dialog box by clicking **OK**, the base material area is displayed in dark gray in the working area.

Always observe that the minimum values (possibly negative sign) are entered under X-MIN / Y-MIN and the maximum values under LOW CORNER.

3.1.4.2	Machine	settings
---------	---------	----------

Click on **CONFIGURATION>SETTINGS** to open the following submenu:

Name : LPKF ProtoMat S62	▼ HF spindle		ОК
Number of tool positions : 10	🔽 Tool box	Milling depth sense	Cancel
Startup	└ Vacuum table _ └ Camera	Write to COMTRAC	E.TXT Initialize
	Vacuumtable be	ight (mm): 0	Lock
Send	Switch off va	cuum after	Кеу
Unit ⊛mm ©inch	Controller C SMCU 1 @ SM	ACU 2 C SMCU 3	Corrections Y Angle:
Maximum speed	Resolution [mm]	Null [mm]	
Rotation [1/min]: 62000	× 0.001	× 0	X-Flip Corr:
Moving [mm/s]: 110	Y 0.001	Y O	Y-Flip Corr:
Z speed [mm/s]: 25	Z 0.001	Z 0	0 Conser Corr Imp
Home (mm) Pause (mm)	Scale factor	Size [mm]	
× 10 × 316.962	× 1	× 316.962	Drill offset [mm]
Y 131 Y 326.28	Y 1	Y 326.28	× 0
Z 0 Z 0	Z 1	Z 44.674	Y O

Fig 25: Submenu machine settings



NAME NUMBER OF TOOL POSITIONS	The drill/mill plotter type will be displayed in this text field, the same type name as indicated on the <i>BoardMaster</i> title bar. This indication is use for information only and has no relevance for the operation process. The number in this text field indicates the num- ber of tool change positions. The number varieds depending on the drill/mill plotter type: <i>ProtoMat 95s</i> always 30, ProtoLaser always 23, LPKF Automill always 7, <i>ProtoMat</i> S62/ S100 10
UNIT	Click on one of the two options to have the length, diameter coordinates and so on dis- played either in inch or metrically.
SEND	Click on this button to send the command in the entry field to the left of the button to the cir- cuit board plotter.
	For this function it is not necessary to click first on the button UNLOCK . For the command syntax please read the manual of the circuit
ROTATION [1/min]	The number in this text field indicates the maxi- mum speed of rotation of the spindle of the cir- cuit board plotter.
MOVING [mm/s]	The number in this text field indicates the maxi- mum speed of movement of the circuit board plotter when the machining head is lifted.
RESOLUTION [mm]	The numbers in these two fields define the distance which the circuit board plotter moves in X or Y direction at one step of the stepping motor. Do not change these values under any circumstances as otherwise the correct scaling of the output cannot be guaranteed.
CORRECTION [mm]	This value (in millimeters) compensates the installation position of the sensor with respect to the tool measurement. This value is part of the <i>ProtoMat</i> S60 factory settings and it is stored in the ini-file.
Write to COM- TRACE.TXT	Click this check box to the log data into the COMTRACE.TXT file.
MILLING DEPTH SENSOR	This function activates the measurement of the surface milling tools (only <i>ProtoMat</i> H100).
CORRECTIONS	Compensates for a shearing angle that developed subsequently between the axes. This setting may only be made under the instructions of the Support Department of the LPKF AG
FLIP CORRECTION	Failures cause by turning around of the cicuit board will be equalized with this function. Change this adjustment under the instruction of LPKF support devision only.
SMCU 3 CONTROL	Controller type SMCU III for <i>ProtoMat</i> S42 (up manufacturing year 2008).
SMCU 2 CONTROL Controller type SMCU II for *ProtoMat* H100, *ProtoMat* X60 (up manufacturing year 2004), *ProtoMat* H60, *ProtoMat* S62.

SMCU 1 CONTROL Controller type SMCU I for LPKF 91s, LPKF92s, ProtoMat 91s, 91s/VS, 92s*,93s and ProtoMat 95s also ProtoMat C20, C30*, C60, C100/HF, M30*, M60 and X60.

BoardMaster is capable to operate two types of control. Selection of the control type is done in the field **CONTROL** and is preset for the circuit board plotter selected in the setup.



Note: The type of control should not be changed as otherwise the correct data transfer with the corresponding syntax is no longer possible.

To prevent a change by mistake of the parameters listed in the dialog field MACHINE SETTINGS if you want to make a deliberate modification you have to click on the button UNLOCK (password protected) to enable the editing of a parameter.

During installation, the machine parameters of the circuit board plotter are read from the initialisation disk that is supplied together with the plotter. Thus all important values like machine size and the position of the **HOME** position (data origin on the axis of reflection) are already programmed at the factory. The circuit board plotter is immediately ready for operation.

All important information like **HOME** position and area of travel must be sent from *BoardMaster* to the control of the circuit board plotter.



Note: In case the individual INI-file is lost it may be necessary to newly initilise the circuit board plotter.

If the plotter parameters must be set anew or corrected, please follow the instructions in chapter "Initialization of Circuit Board Plotter" on page 104.

A chain of commands in plotter syntax can be entered in the text field **START LINE**. The commands are stored in the initialisation file when *BoardMaster* is closed and are sent to the circuit board plotter when *BoardMaster* is started.

All inputs in the dialog field **MACHINE SETTINGS** are transferred to the plotter when **OK** is clicked to leave the program and they are stored in the initialisation file when *BoardMaster* is closed. Thus they are available at each new start of the program.



3.1.4.3 Tool library

The *BoardMaster* program provides tool libraries containing tools available from LPKF with all specific tool settings. The tool library files are available in three versions: *.TOL for drilling and milling tools, *.DIS for dispensing needles and *.VAC for evacuation needles (only with LPKF AutoContac). All lists can be changed and stored for later use.

Click on **CONFIGURATION>TOOL LIBRARY** to get access to the several tool libraries:

Fig 26: Tool library submenu

Material	•	
Settings		
Tool Library	•	Mill/Drill
Heads		Dispenser
Vacuum system		Vacuum
Connect	Т	
Tool box		
Phases		
Define Exchange Positi	ion	
Fiducial Sattians		

The tool library contains the definitions of all necessary tools inclusive their characteristical features for the circuit board plotter operation. To add tool or change existing tools the following parameter description must be observed.

Click on CONFIGURATION>TOOL LIBRARY>MILL/DRILL to open the following dialog box:

Mill/Drill Tool Edit	
	New OK
	Delete Cancel
	Replace Load
	Save
	Millingset value
	Life cycle [mm or no. of holes]
	Maximum: 0
Diameter [mm]: 0 Mill	Working mode C Throughput (fast)
HeadDownTime 0 O Drill Description:	C Balanced (normal) C Quality (slow)
Z-Travel [mm]:	Optimal speed Rotation [1/min]: 0 Speed [mm/s]: 0
C 36 mm length C 38 mm length	
] []

Fig 27: Mill/Drill tool edit menu



NAME LIST	This list field contains the name of the tool. The selection of the name should provide information on the type of tool to facilitate later selection in other program sections. After selecting a tool in the list field, you can display its settings and change them if required. The names selected here must coincide with those in <i>Circuit-CAM</i> . This name allows automatic tool assignment when importing LMD files
DIAMETER [mm]	The number in this text field indicates the dia- meter of the tool. This value allows automatic tool assignment when importing LMD files and the display of the actual diameter in the gra- phic working area.
HEAD DOWN TIME	The number in this text field indicates the time interval in seconds between the command "Lower head" and the command "Raise head" for the drilling tool.
DRILL/MILL	The tool can be defined as a milling or drilling tool by clicking one of these two options
DESCRIPTION	An additional description of the tool can be entered in this text field. However, this specifi- cation has no significance for the production sequence.
LIFE CYCLE [mm or no. of holes]	The number in the text field MAXIMUM speci- fies the maximum cutting path or maximum number of holes for the tool. In the text field PRESENT ; the cutting path already cut or the current number of holes for the tool is indica- ted.
	The tool change procedure can be started by clicking REPLACE and after replacing the old tool, the specification in the text field PRESENT is reset to 0.
OPTIMAL SPEED	The speed in the text field rotation defines the optimum rpm for the machining spindle. The number in the text field MILLING defines the optimum feed rate for milling tools.
MILLING INFEED [mm]	Value in millimeters for milling depth (engra- ving tools L=36mm) and infeed (cutting mills L=38mm). All milling tools that only machine the surface of the material or engrave it pene- trate into the material with this value, after the zero position was detected by the depth sensor prior to that. Cutting mills are not detected by the depth sensor. Then the value only indicates the further infeed.
WORKING MODE	Here parameter sets or profiles can be assi- gned to each tool. There are the profiles THROUGHPUT, BALANCED, QUALITY . Parameters speed, acceleration and dwell times can be stored for each of the three axes, they apply to "lower head" (drilling) and "head down" (milling). These profiles are stored in an MCH-file and are preset for the various wor- king mode profiles.





Note: The speed is used automatically only for circuit board plotters with variable spindle speed. For all other circuit board plotters with variable motor speed, the optimal speed must be set by hand on the control. The optimal speed to be set is, however, indicated by *BoardMaster* upon tool change.

All changes in the tool library can be stored in a tool file (*.TOL) and loaded again later. The file to be loaded when *BoardMaster* is started can be defined in the machine file "*.MCH" with the command "#INCLUDE".This also applies for production phases, the dispenser and vacuum tools.

By clicking on **SAVE** all changes of the tool file (*.TOL) will be saved. Click on **LOAD** to reload this data file later on.



3.1.4.4 Heads

Select CONFIGURATION>HEADS to open this dialog box:

Fig 28:	Dialog	box	Heads
---------	--------	-----	-------

Heads			×	
Head Mill/Drill Dispenser/Vacuum Vacuum/Dispenser Camera		Offset [mm] X 0 Y 0		
Auto				
ОК	Cancel	Origin Head		

The tool heads are listed on the left side and the corresponding offsets are in the X/Y text fields on the right side of the window:

HEAD	The milling/drilling head serves as a reference for all other options mounted on the head. Its offset should therefore always be set to $X = 0$ and $Y = 0$.
OFFSET [mm]	The distance between a light dot or camera option mounted on the machining head and the machining head is defined here. This can be used for precise positioning for reloading cir- cuit boards already completed.
AUTO (<i>ProtoMat</i> S62/S100 only)	A detailed description of how these offsets are calculated is given in the following chapter. This function is used to calibrate the camera offset automatically. The calibration process needs a inserted tool and a base material fixed on the object table.



3.1.4.5 Vacuum system

Select **CONFIGURATION>VACUUM SYSTEM** to open this dialog box:

Fig 29: Dialog box vacuum system



Use the submenu **VACUUM SYSTEM** to call up the status of the vacuum system. The operation hours will be reported.

3.1.4.6 Connect

Select **CONFIGURATION>CONNECT** to open this dialog box:

Connect		
Settings:		
Control:		SMCU 1
Machine:		
Firmware:		
Interface ty	/pe:	RS232
COM Port:		COM1
Baud rate:		9600
8	Check the s switched or Press ''Con ''Cancel'' to mode.	setting and whether the machine is h. nect" to contact the machine, or start BoardMaster in offline
Connect]	0K Cancel

Version 1.0

Fig 30: Dailog box connect



CONTROL	Inserted automatically
MACHINE	Selectable machine configurations:
	H100 –2003-:
	Protomat H100 Manufacture Year 2003
	H100 –2004-:
	ProtoMat H100 Manufacture Year 2004
	H60
	ProtoMat H60
	S-Serie (Firmware 2.7.9)
	ProtoMat S62/S100
	ProtoMat S42
	SMCU_2AX:
	<i>ProtoMat</i> 91s, 91s/VS, 92s, 93s, C20, C30,
	C30s, C40, C60, C100/HF, M30s, M60,
	M100, L60, X60
	SMCU_2AX Toolchange:
	ProtoMat 95s, 95s/II
	SMCU3AX:
	<i>ProtoMat</i> D100, M60/3D
	X60:
	ProtoMat X60/II
	X60 III:
	ProtoMat X60 / III
FIRMWARE	Display of the particular firmware version.
INTERFACE TYPE	Used communication ports of the control PC.
	Selectable interfaces RS 232 of USB (USB
	motion net™ controller - Firmware undate nos-
	sible)
COM PORT	Selection of the computer interface with is con-
	nected to machine
BAUD RATE	9600, 38400 or 57600 depending on the con-
	nected ProtoMat type.
CONNECT	To establish the connection to the machine
	click the CONNECT button.

The editable parameter of the serial interface for the several Circuit Board Plotter types are listed in the table below:

	David					
type	Rate	Data Bit	Stop Bit	Parity	Protocol	FIFO
LPKF 91s / 92s ProtoMat 91s, 91s/VS, 92s*, 93s und 95s* ProtoMat C20, C30*, C40, C60, C100/HF, M30*, M60 und X60	9600	8	1	non	Hard- ware	No
ProtoMat H100, H60, S62/S100	57600	8	1	non	Hard- ware	Yes
ProtoMat S42	38400	8	1	non	Hard- ware	Yes



Note: Using the *ProtoMat* S62 or S42 the FIFO buffer must be actived (see table above)!



Set this parameter via Windows system control:

Windows 2000/XP: System - Hardware - Device manager (Login: "Admin"!!!)

Check the connection between the computer and the circuit board plotter if *BoardMaster* get no access to the circuit board plotter after the startup of the program.

Also compere the serial interface parameter of the *Windows* system control with the listed parameter in the table above.



Note: The main reason for a faulty communication are not correct protocol settings for the serial interface. Take care that Hardware handshake and not XON/XOFF is used for protocol.

3.1.4.7 Tool box

Note: The ProtoMat S42 do not support this function.

Fig 31: Dailog box connect

ool Bo	X				
Pos.	Name	×Position	yPosition	Current [mm]([Maximum [mm
1	Micro Cutter 0.1 mm (4 mil)	-3.5734	149.7061	25494	6000
2	Universal Cutter 0.2 mm (8 mil)	30.3951	149.6603	90222	50000
3	End Mill 1.0 mm (39 mil)	64.3179	149.5990	48333	20000
4	Spiral Drill 0.5 mm	98.2710	149.4266	5	3000
5	Spiral Drill 0.9 mm	132.3658	149.4984	46	4000
6	Spiral Drill 1.0 mm	166.3959	149.5099	12	4000
7	Contour Router 1.0 mm (39 mil)	200.4287	149.6318	3529	7000
8	Spiral Drill 2.0 mm	234.3405	149.7098	17	2000
9	Spiral Drill 1.0 mm	268.3367	149.7078	32	4000
10	Contour Router 2.0 mm (79 mil)	302.4036	149.8388	1501	8000
е ц С п	Jp © Open Down © Close	- P	Check Iositions: 10	Apply current posi	tion
Che	ck toolpositions				
₽	Position 1 🔽 Posit	osition 1 🔽 Position 6		Start Sto	p!
₹	Position 2 🔽 🔽 Posit	osition 2 🔽 Position 7			
₹	Position 3 🔽 Posit	ion 8	Runs : 1		
_	Decition 4 🗸 Decit	ion 9	Bune accompliched		
V			Runs	s accomplished :	

Pos. 1 to 10	List of tools.
Head	Click on the radio button UP to lift the head for 5 mm. Click on the radio button DOWN to drop the head for 5 mm.
Main/Aux. Clamp	Click on the radio button OPEN to open the main clamp or aux. clamp (H100). Click on the radio button CLOSE to close the main clamp or aux. clamp (H100).



Tool position	Click on the button CHECK to check a selec- ted tool position. Click on the button INTERPO- LATE to calculate the tool positions 2 to 9 automatically, when tool position 1 and 10 are already known. Click on the button APPLY CURRENT POSITION to accept the manual correction of the tool position.
Check tool position	Click the check box 1 to 10 to define the tool positions for the check procedure.
Start/Stop	Click on the button START to start the check procedure for the selected tool positions. Click on the button STOP to finish the check proce- dure. The value in field RUNS define the num- ber of check procedure repeats.
Service	Click on the button SERVICE (password protected) to change the parameters and settings.
OK Cancel	Click on the button OK to save the settings.
	without taking over the actual settings.

3.1.4.8 Phases

All data to be transferred to the circuit board plotter by *BoardMaster* must be assigned to a certain production phase. These production phases define a work sequence which does not require any manipulations by the user. An example of such a manipulation would be through contacting the circuit board or turning the base material. The only exception here is manual tool change. This assignment is prepared in *CircuitCAM* and is accomplished automatically in *BoardMaster*.

Some production phases are already defined in the initialization file. However, you can adapt these production phases to your specific requirements at any time. The names of the production phases must coincide in *CircuitCAM* and *BoardMaster*.

Click on **CONFIGURATION>PHASES** to open the dialog box:



All standard defined production phases are listed in the list field. After selecting a production phase, you can view its settings and change them if required.

Two settings are required for each production phase:

- The color with which the data assigned to this production phase is to be displayed. This setting serves for differentiation of the various production phases on the working area.
- Definition of the circuit board side (visible = component side or reversed = soldering side) for the production phase. Mark the indicator box **REVERSE SIDE** for all production phases for processing the bottom of the circuit board. All other production phases for which the indicator box **REVERSE SIDE** is not marked, are defined for processing the top.

Generating a new prduction phase:

- Inside production phase listmark the production phase where the new production phase will be inserted above or below.
- > Edit name of the production phase into the text field.
- To insert the production phase on the relevant position click on INS ABOVE or INS BELOW.

Fig 32: Dialog box phases

By clicking **SAVE** all changes within the menu **PHASES** will be saved in a phase definition file (*.PHS) and can be loaded by clicking the **LOAD** button.



Note: On one-sided material, the option "REVERSE SIDE" should be activated for the phase "CUTTING OUTSIDE"! This eliminates the necessity of turning the base material.

Intention of the phase files:

1-2layer.phs	Production of a 1 or 2 layer printed circuit board.
4layer.phs	Production of a 4 layer (Multilayer) printed circuit board (sequential build-up method).
6layerpin.phs	Production of a 6 layer (Multilayer) printed circuit board (registration pin method).
8layerpin.phs	Production of a 8 layer (Multilayer) printed circuit board (registration pin method).
soldermask.phs	Cutting of solder foil "system EasySolder"



3.1.4.9 Define the tool change position

This function must be used by machines without tool change bank. Click on **CONFIGURATION>DEFINE CHANGE POSITION** to open the following sub menu:

Fig 33: Position read

Po	sition read
	Unlock
	X-Position in mm 0.000
	Y-Position in mm 0.000
	Read
	Cancel

UNLOCK	Click on the UNLOCK button to read in a new tool position
READ	After the machine is moved to the relevant position this position can be saved by clicking the READ button.
CANCEL	Click the CANCEL button to leave this menu.

3.1.4.10 Fiducials

Click on **CONFIGURATION>FIDUCIALS** to open the following sub menu:

Recognition indicator [%]		-		
1. Immediately recognized	98	4. Spiral search area size [mm]	5	ОК
2. Try on next spiral	40	5. Show fiducial for a period of [s]	0	Default
position if lower than: 3. Move to center if	10	6. Max. stretch threshold [%]	0.1	Clear fid.
improvement higher than:	4	Alianment		Cancel
		Anymnent		
Damping time [ms]	0	-Required no. of fi	ducials	
Axis play security X [mm]	0	C 2	03	· 4
Axis play security Y [mm]	0	Confirm fiducial	after	Settings

Recognition Indicator [%]

1 Immediately recognized if higher than

Edit a value to define the acceptance of the camera analysis (default: 98)

Fig 34: Fiducial settings

2 Try on next spiral position if lower than	Edit a value to define the point where the camera analysis will not detect a object as an fiducial (default: 40)
3 Move to center if improvement is higher than	Edit a value up to this point the divergency of the fiducial detection will be ignored (default: 4).
4 Spiral search area size [mm]	Edit a value to define the dimension of search area (default: 5).
5 Show fiducials for a period of [s]	Edit a value to define the display time for detected fiducials.
6 Max. stretch threshold [%]	Edit a value to define the maximum divergency between reality area and the fiducial detection area (default: 0.1).
ОК	Click on the button OK for taking over the set- tings.
DEFAULT	Click on the DEFAULT button to reload the factory settings.
CLEAR FID.	Click on CLEAR FID. to delete the number of required fiducials.
CANCEL	Click on the CANCEL button to leave the menu. All settings will not taking over.
Calibration	
Damping time [ms]	Edit a value to define the measuring delay time (default: 0).
Axis play security X [mm]	This function is not supported. The value must be 0.
Axis play security y [mm]	This function is not supported. The value must be 0.
Alignment	
Required no. of fiducials	Click on radio button 2, 3 or 4 to define the number of searched fiducials.
Confirm fiducials after recognition	Click on the check box to get a confirm mes- sage after every check procedure.
Settings	Click on the button SETTINGS to change the camera contrast, brightness and so on.

3.1.5 Go to menu



Danger:When an entry in the menu GO TO is selected, the connected circuit board plotter starts moving! The hazard of pinching and crushing exists!

For this reason, ensure that no one can enter the motion range of the circuit board plotter during the operating phases!

This menu provided functions for moving the drill/mill head to definded positions:



Fig 35: Go to menu (S42)



Fig 36: Go to menu (S62/S100/ H100)



HOME	Select HOME to move the the drill/mill head to the HOME position (data origin).
PAUSE	Select PAUSE to move the drill/mill head to the PAUSE position (standard Xmax/Ymax).
EXCHANGE (Proto- Mat S42 only)	Select EXCHANGE to move the drill/mill head to the exchange position (standard Xmin/ Ymin).
EXCHANGE (user- defined, <i>ProtoMat</i> S42 only)	Select EXCHANGE (user-defined) to move the drill/mill head to the user-defined exchange position .
ZERO POSITION (<i>ProtoMat</i> S62/S100 only)	Select ZERO POSITION to move the drill/mill head to the tool change position (default: Xmax/Ymax).
CAMERA >> HEAD (optional)	Select CAMERA>>HEAD to move the camera to the actual position of the drill/mill head.
HEAD >> CAMERA (optinal)	Select HEAD>>CAMERA to move the drill/mill head to the preset (original) position.

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3.1.6 Help menu

Click on menu **HELP** to get the actual program information:

Fig 37: Program information

About BoardMaster
Microsoft Windows98/NT/2000/XP
Board Master
Version 5.1.103.0
27
VC_API: MotionIO Vers. : Steuerung: Firmware:
Copyright © LPKF Laser & Electronics AG 1991-2008
Written by LPKF Laser & Electronics AG

> Click on **OK** to close the menu.



3.2 Function bar

The function bar in *BoardMaster* includes functions for positioning and copying projects on the base material as well as for control of the connected circuit board plotter. Moreover, the function bar provides important status information on the machining process.

This short summary contains a list of all features in the function bar. The individual features and meanings are explained briefly. Each function includes a reference to the corresponding page in the manual containing a detailed explanation when present. The hot keys for the function are also listed following the page number.



1- Display or selection of the active job phase

- 2- no function
- 3- no function
- 4- Display: Quantity drill hols or length mill line (in mm)
- 5- Connect LPKF-Online-Shop

- 6- Display: Drilling process time (in s) or feed motion (in mm/s)
- 7- Display: Speed drill spindle (unit: 1/min)
- 8- Display. Impact depth of the tool (in mm) only H100
- $\ensuremath{\textbf{9}}\xspace$ Display or selection of the active phase

Fig 40: Tool and control functions

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- 1- Display: Configuration Phase
- 2- Display: Configuration "Active Tool Library"
- 3- Dialog box: Tool Position
- 4- Switching ON/OFF vacuum/exhausting
- 5- Switching ON/OFF milling spindle
- 6- Display interface

Fig 41: Milling functions

7- Drive drill/mill head to coordinates zero point

8- Drive drill/mill head to HOME position

9- Drive drill/mill head to PAUSE position

10- positioning of the XY table with the computer mouse **11**- ?



- 1- Camera function: adjust fokus optional
- 2- Camera function: fix fokus optinal
- 3- Camera function: stop fokus optional

Fig 42: Marking functions

4- Display: vector index

5- Manual movement drill/mill head Z axis

6- Manual movement drill/mill head X/Y axis



1-Select area - lines crossing the area

- 2- Move project
- 3- Activate/deactivate marked lines
- **4** ?
- 5- Display: Quantity marked lines
- 6- Undo marking data

- 7- Marking data of all production phases
- 8- Erase selected data from mark
- 9- Add selected data to mark
- 10- Select area lines inside the area
- 11- Duplicate project



3.2.1 Status information

Fig 43: Status information



1	INTERFACE	This display provides information on the interface set for transferring the control data. Here NULL means that the data is not sent to an interface. When the mouse is moved over this display field, the values set for the interface are indicated in the status bar.
2	Actual mill/drill head position	Display of the actual drill/mill head position with all three axis: X/Y/Z.
3	Vector quantity	Display the number of finished project vec- tors.
4	2.5D MODE	The thickness of the material is divided into various processing layers. The num- ber of layers depends on the depth with which the tool penetrates the material. The penetration depth must be individually adapted to each tool. The settings that are made can be stored in the hob. When the option is enabled with a checkmark, then the following dialog appears.
5	Duration estima- tion	Display of the estimated duration time in hours:minutes with is calculated for the activated production phases. Single selec- tions will not included in the time calcula- tion.

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3.2.2 Changeable parameter

The display fields indicated here can be edited and thereby adapted to your requirements.

Fig 44: Changeable parameter

ter Board Master] - <default></default>						
File Edit View	Configuration Go to	o Help					
	ک 🖬 ک	*o o	Q Q	°a 🐔	¢%≎ <mark> }</mark> û	X: 0.00	🐔 🐔 + All+
< unknown >				- 8	* 🙆 🗘 🛛	➡ 0 Y: 0.00	🗧 💷 - All- Start
	T		-	- m	V 0 V		
			_))		NULL!	Settrocus Stop	0:04:04
1 1	4						
1		2				2	4
		2				3	-
			1	ΤοοΙ		This list field shows	s the tool used for the
			•			current production	nhase
			0	Current	production	The ourrent production	tion phone is indicated
			Ζ	current	production	in this list field	stion phase is indicated
			_	phase	_		
			3	Step size	efor	This text field allow	is definition of the step
				manual o	control	width by which the	drill/mill head is moved
						each time one of th	ie six Arrow buttons
						(outlined with dotte	d line in figure above) is
						clicked. The text fie	and can be marked and
						the value can be in	icreased or decreased
						in defined steps wi	th the + or - button.
			4	Vector in	ldex	This text field allow	is you to define the vec-
						tor index. An index	is counted with each
						line segment or arc	segment. Here, it is
						possible to define t	ine vector index at
						which processing is	s to be started, for
						example.	



3.2.3 Positioning functions



Move projekt

Activate this button to move a project in the operating area. Position the cursor on the project to be moved, press the left mouse key and drag the project to the desired position with the mouse key depressed.

The project appears as a dark area while it is being moved.

1 Duplicate project

Activate this button to duplicate a project and position the copy in the operating area. Position the cursor on the project to be duplicated, press the left mouse key and drag the copy of the project to the desired position with the mouse key depressed.

The copy of the project is represented as a dark area during duplication.



Note: Each time a project is moved or duplicated it is necessary to reactivate the corresponding button.

Click a project with the right mouse key to open the PLACEMENT dialog box and display the settings for this project.

In this dialog box you can correct the reference point values for positioning projects on the same X and Y coordinates (align). If the control key is pressed and held down, while clicking and holding down the left mouse key on the project, the project is moved only in the X or in the Y direction.

You can also use the PLACEMENT dialog box for rotating a project (after positioning with the mouse) by changing the setting ROTATION.

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3.2.4 Manual control functions



Danger! After activating one of the following buttons on the function bar, the connected circuit board plotter is put into motion! Ensure that no one can move into the hazard area of the plotter during the operating phases controlled by BoardMaster!



Manual control

The head can be moved in the directions +X, +Y, -X and -Y with the aid of the arrow keys. Pressing one of the arrow keys once, moves the head by the value entered on the function bar in the entry field STEP FOR MANUAL CONTROL in the selected direction (See "Changeable Settings" on page 24). Motion in the X and Y direction can also be accomplished by holding down the Ctrl key on your keyboard and pressing the arrow keys on the keyboard. The Z-axis can be moved with the keyboard by pressing the Ctrl key and actuating the Page \uparrow or Page \downarrow key.



Move using the computer mouse

Click this buttons to move the drill/mill head to the position in the operating area which you click with the left mouse button. If you continue to hold down the left mouse button, you can move the mouse and the head follows the motion of the mouse after it has reached the mouse starting position. This function allows the head to be moved to any desired location very quickly for defining the material size. To control the XY table with the mouse motion again it is first necessary to activate the button again.



Home position

Click this button to move the drill/mill head to the **HOME** position. This position is principally moved to in order to check the existing reference hole system or to produce a new one.



Zero point

Click this button to move the drill/mill head to the zero point of the X-Y coordinate system. This position is generally moved to before switching the circuit board plotter off

Vacuum UAC

Click this button to switch the vacuum system ON or OFF. Please note that the vacuum system cannot be switched OFF when the drill/mill spindle is running.



Drill/mill spindle ON/OFF

Click this button to switch the drill/mill spindle ON or OFF.



Pause position

Click this button to move the drill/mill head to the Pause Position. This position is used when material is to be exchanged or when material is to be turned round.



3.2.5 Selection functions

Before selecting, you must have activated all phases to be assigned data and which you want to process. Detailed information on activation is given in the chapter "Phases". Data must be selected before it can be sent to the plotter for processing. Only data in the activated phases can be selected.

The following buttons are available on the function bar for selecting the data:

Mark all

Click this button to mark all data for the enabled production phases. The data marked are displayed in a lighter color on the monitor.



Cancel mark all

Click this button to cancel all marking of the data.



Select area

Click this button to select a data area. For this purpose, press the left mouse key and hold it down while dragging the mouse over the desired area.

This function also selects lines crossing the area. The selected data are displayed in white on the monitor.



Select area (only inside)

Click this button to mark a data area. For this purpose, press the left mouse key and hold it down while dragging the mouse over the desired area.

This function marks lines crossing the marked area only up to their first support coordinate outside of this area. The marked data is indicated in white on the monitor.



Note: It is necessary to reactivate the corresponding button each time an area is selected.



Mark selected data

Click this button to add selected data to the marking.



Cancel selected data

Activate this button to delete selected data from the current marking.



Selected lines

Increase or decrease the number in the window with the small arrow buttons to the right. Each number stands for a certain vector (section of line). The entire job is processed vector for vector in the sequence of this numbering. It is possible to select a certain vector or a number of vectors for subsequent marking. For this purpose, it is necessary to select the number of the corresponding line with the aid of the right arrow button. Then, it is necessary to activate the function "Selected lines" by clicking

You can then increase or decrease the number with the arrow buttons to select each selected vector and display it in white on the monitor. These selected lines can be marked by clicking + or added to a marking. If vectors already marked are selected in this manner, they can be unmarked by clicking - .

This function can be deactivated by clicking **I**.

Furthermore this function allows to select a project to start with a determined vector index value. Enter the vector value from which the project

is to be processed. Confirm the function with and then the vector value is increased using the keyboard entry (for example by adding a number, e.g. 564 becomes 5640). The subsequent routes are then rep-

resented in white and can be added to the selection by pushing the button.



3.2.6 Production phase control function



Danger! After activating one of the following buttons on the function bar, the connected circuit board plotter is put into motion! Ensure that no one can move into the hazard area of plotter and come into contact with the tools during the operating phases controlled by *BoardMaster*!



Start Click this button to transfer the marked data for the enabled production phase to the plotter over the serial interface.



Stop Activate this button to discontinue data transfer to the plotter after starting.



Attention: After clicking the stop button, the plotter does not stop immediately; first, it continues to process the data in the buffer! The click on the stop button only interrupts transmission of data to the plotter!



4 **Production process**

This chapter describes the principle procedure to produce a prototype of an double-sided, not through connected circuit board with *BoardMaster* step by step.

You will learn to work with *BoardMaster* and the circuit board plotter shortly if you adhere the following instructions.

4.1 Preparing BoardMaster start

For error-free operation with your circuit board plotter, it is absolutely necessary to observe the switch-on sequence specified below:

- Switch on the circuit board plotter.
- Wait until the green operating indicator on the front panel or the data LED on the back panel of the circuit board plotter light up.
- Start BoardMaster.

Otherwise the communication between computer and circuit board plotter can not be implemented after the *BoardMaster* program starts.

4.1.1 Start BoardMaster



> Double-click on the *BoardMaster* on the desktop.

Or click on Start>Program>LPKF Laser & Electronics AG> BoardMaster

The BoardMaster startup window will be opened:



This image may be visible for up to 8 seconds, which is related to the communication between the PC and the machine, it does not represent an error. After this time period, the program start is automatically continued.

Fig 45: Startup screen



- > If the message CONNECT.. will be opened:
 - Check the power switch of the ciruit board plotter position I (ON). Check the data connection cable between computer and circuit board plotter - interface plugs and cable are correct installed.
 - Check the connection settings (see chapter 3.1.4.6 "Connect" on page 40).

The BoardMaster operation interface will be opened.

BoardMaster is waiting of corresponding message of the drill/mill head (the continuing movement of the drill/mill head).

As soon as the plotter sends the requested reply to the computer, the program is continued normally.



4.1.1.1 Tool status



Note: The following informations refer to the *BoardMaster* application with *ProtoMat 95s*, 95s/II and S62!

Using a *ProtoMat 95s*, *95s/II*, H100 S62 or S100 the dialog box **TOOL STATUS** will be opened after starting *BoardMaster*.

Fig 46: Tool status

Where is the tool ?—	
🔿 in the main clamp)
C in the exchange of	lamp
C in the auxiliary cl	amp
Enter the free	tool position : N



<u>Caution:</u>It is absolutely necessary to establish where a tool is located at switch on. Then, the free tool position can be entered in the tool box. <u>Note: Position 1 = Tool 1 all the way to the left. Posi-</u> tion 30 = Tool 30 is therefore all the way to the right in the tool box

After starting *BoardMaster* for the first time, the **TOOL STATUS** dialog box appears as illustrated above. The actual status, meaning where a tool is located and which position is free in the plotter tool box for this tool, must be defined by the user. Each time the program is restarted, the tool status present the last time the program was closed is displayed. This can then be confirmed simply by pressing **OK**.

If the status displayed does not coincide with the actual status, it is necessary for the user to correct the status.

Then, the program asks whether the tool is to be put back in the tool box upon exiting *BoardMaster*.



4.1.1.2 Check interface

If the circuit board plotter are not detected automatically the dialog box **CONNECT** will be opened. In this case the connection settings must be changed.

g 47: Dialog box Connection	Connect	
	Settings:	
	Control:	SMCU 1
	Machine:	
	Firmware:	
	Interface type:	RS232
	COM Port:	СОМ1
	Baud rate:	9600
	Check th switched Press "("Cancel" mode.	he setting and whether the machine is d on. Connect" to contact the machine, or " to start BoardMaster in offline
	Connect	OK Cancel

- > Make sure that the circuit board plotter is switch on. Check the control light on the drill/mill head - the light must lit on.
- Make sure that the needed settings of the Circuit Board Plotter are inserted and check the system settings of *Windows* (see installation instruction).

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> Click on CONNECT.

The following window will be shown:

Connect...



Fig 48: Dialog box Connection

Connect	
Settings:	
Control:	SMCU 2
Machine:	LPKF ProtoMat S100
Firmware:	FW 2.7.9
Interfacetype:	RS232
COM Port:	COM1
Baudrate:	57600
Press config Press the m	s "OK" to operate the machine with this guration. s "disconnect" to seperate the contact to lachine.
Disconnect	OK Cancel

When the communication between computer and circuit board plotter has been successfull established the *BoardMaster* operation interface will be opened.

Note: By clicking **CANCEL** the *BoardMaster* operation interface will be opened but the circuit board plotter can not be controlled via software. To change the connection settings click on **CONFIGURATION>INTER-FACE** and use the **CONNECT** dialog box to establish a connection to the circuit board plotter.

[] The *BoardMaster* operation interface will be opened.



4.1.2 Insert base material

Click on GO TO>PAUSE to move the drill/mill head to PAUSE position.

We recommend using the base material already present on the circuit board plotter. The first base material board is already mounted for precisely this reason to make introduction easier for you. Drilling and positioning material of other sizes is not described here.

 Fasten the base material with adhesive tape on all four sides (we recommend Tesakrepp 5250).

Further steps for all ProtoMat types:

In order to process data created with *CircuitCAM* or similar software, it is first necessary to import them into *BoardMaster*.

View base material:

The work area of the base material must be visible on the monitor. Define the the displayed sector via *BoardMaster*. This definition has no influence on the production process.

Fix material size view:

Define the base material size.

4.1.3 Import production data

The "Working Instructions" for *BoardMaster* indicating the method for processing the base material are contained in the production data. They are generated by *CircuitCAM* or a similar program and must first be imported:

You can import the LMD production data (e.g. TUTOR.LMD) generated by the *CircuitCAM* software or the HP-GL project files already generated by *BoardMaster*. At this point, we will now import a file in LMD format (Tutor.Imd).

 Import the file Tutor.LMD by clicking the entry LMD or LPR...in the submenu IMPORT in the menu FILE and select a file (e.g. "Tutor.LMD"). This file can be found in the directory C:\Program files\LPKF50\Data\.

Tool allocation:

A tool must be assigned to each production phase so that *BoardMaster* "knows" which tool to use for each individual program phase (milling cutters, drills of different sizes, engraving, etc.). As a rule, *BoardMaster* accomplishes this itself, as is the case when importing Tutor.Imd. However, if you are processing an HPGL file, this will have to be accomplished manually. In this case, please read the next Chapter "Assigning Tools" on page 85 before continuing here.

If you are working with an HP-GL file, assign the appropriate tools/ phases to the imported production data for projects (EDIT>TOOL



ASSIGNMENT). Otherwise, simply continue on to the next processing step.

Place production data:

You now have the possibility of positioning the imported production data as desired on the base material to define how they are to be machined later.

> Position the imported production data or projects by selecting the

entry **PLACEMENT**... in the menu **EDIT** or click the button \square on the function bar. You can then move the image of the production data with the mouse and position it by holding down the left mouse key..

Save Job

 Click on FILE>SAVE AS to save the job under a customized name after all projects are placed.



4.1.4 Select first production phase

Each production phase such as "Milling bottom" must be selected separately and prepared for processing (assignment of correct tool, etc.). Start with the first production phase:

 Select the production phase "Milling bottom" from the function list in the list box **PRODUCTION PHASE** (see figure below).

Fig 49: List production phase Milling Bottom



Mark data:

Theoretically, it is possible to process only certain sections of this production phase by correspondingly selecting the data. For this reason, it is always necessary to first select the desired areas to be processed. Since the entire production phase is to be processed here, we select all data for this phase:

> Click on All+



Danger!Activating one of the following buttons on the function bar, sets the connected circuit board plotter in motion! The danger of pinching and crushing exists!

Ensure that no one can enter the hazard area of the circuit board plotter during the operating phases controlled by *BoardMaster* or come into contact with the tools!

Starting milling operation for selected production phase:

to mark all data.

Start

> Click on **Stop** to transmit the mark data to the circuit board plotter via the serial interface.

If you use a machine without automatic tool change, the machine first moves to the tool change position if not already positioned there and the following message appears: Laser & Electronics _

Fig 50: Tool change

Tool Exchange
Insert the tool Universal Cutter 0.2 mm (8 mil) / 40000 rpm into the Mill/Drill head when it stops
Action
© Continue after tool exchange
C Stop after tool exchange for adjustment
ОК

This message always appears when a tool is to be changed. If you use a *ProtoMat* S62/S100/H100 then skip the following steps.

- Now install the first tool required in the machining head (see machine manual).
- > Click "Stop for change after tool transfer" and then click **OK** to close the message box.
- Now set the cutting depths if you are operating the circuit board plotter for the first time.



> Switch on the vacuum!

 Click on
Start Stop
again.

The production phase "Milling bottom" is run. Then the following message appears:

Fig 51: End phase

🗖 Board M 🔀
End of the phase !
Duration 0:00:23
ОК

> Click on OK.

Fig 52: List production phase

Drilling Plated



4.1.5 Select second production phase

 Select the production phase Drilling Plated on the function bar in the list box PRODUCTION PHASE (see figure below).



Mark data:

> Click on All+ to mark all data.



Danger! Activating one of the following buttons on the function bar, sets the connected circuit board plotter in motion! The danger of pinching and crushing exists!

Ensure that no one can enter the hazard area of the circuit board plotter during the operating phases controlled by *BoardMaster* or come into contact with the tools!

Starting drilling operation for selected production phase:

Start

Click on Stop from the function bar to send the selected data for the current production phase to the circuit board plotter via the serial port.

The message "Tool Change" appears.

- > Now install the required tool.
- Click Stop for change after tool transfer and then **OK** to close the message box.
- > Adjust the drilling depth.
- > If necessary, click Continue after tool transfer and then click OK.



> Switch on the vacuum!



Click on Stop again.

The production phase is completed.

Continue to comply with the subsequent drill requests by installing the tool (drill) as requested and then click **OK** until the production phase is completely processed.



Turning base material:

After drilling and milling the bottom, move the head to the Pause position (menu bar GO TO-PAUSE) and turn the base material around the X axis and fasten it again with adhesive tape.

4.1.6 Select third production phase

 Select the production phase Milling top on the function bar in the list box PRODUCTION PHASE.



4.1.7 Select fourth production phase



Note: In this production phase, the circuit board is cut out of the base material. During this operation, pay attention to the cutting depth of the milling tool used here. (!)In this particular case(!) adjust the milling depth visually! If required, in the same manner as



adjusting the drilling depth. Here, it is important that the cutter cut through the entire thickness of the base material without cutting deeply into the drilling subsurface!

Select the production phase CUTTING OUTSIDE on the function bar in the list box PRODUCTION PHASE.

Mark data:

> Click on the ALL+ button to mark all data.



Danger!Activating one of the following buttons on the function bar, sets the connected circuit board plotter in motion! The danger of pinching and crushing exists! Ensure that no one can enter the hazard area of the circuit board plotter during the operating phases controlled by *BoardMaster* or come into contact with the tools!

Starting milling operation for selected production phase:



> Switch on the vacuum!

> Click on the START/STOP button of the function bar.

The selected data of the actual production phase will be transmitted to the circuit board plotter via the serial interface.

The operations for changing tools and setting the milling/drilling depth are repeated. Proceed as described for the first production phases.



Note: Observe that it is always necessary to switch the auto motor function back on before proceeding after any adjustment of the drilling or milling depth!

> When the production phase "Cutting outside" has been completed, move the circuit board plotter to the PAUSE position.

The double-sided circuit board is now finished. It can be broken out of the base material carefully. If you want to process the data for other production phases (dispensing, milling inner layers of a multiple layer board, etc.), follow the instructions above in the same manner for these phases. For this purpose, read the corresponding chapter in the manual.

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4.2 Tool change

4.2.1 Manual tool change

The list **TOOLS** inside the function bar is listing all tools of the tool library. On top of the list are the tools with will be used during the actual production phase, marked with "*":

Fig 54: Tool list



If no production phase is selected the first production phase of the production phase list is active.

When processing a production phase, the user are always requested to install the tool to be used next when a tool change is required.

If a different tool is selected from the list, the machining head moves to the tool change position. Simultaneously the message appears on the screen that the present tool is to be replaced with the tool just selected.



Danger: This instruction starts the circuit board plotter. Danger of pinching and crushing! Also observe safety precautions for changing tools in the circuit board plotter manual!

After changing the tool, and confirming the change by clicking **OK**, processing can be continued with the next control commands.

4.2.2 Automatical tool change

The following dialog box can only be called up when machines with automatic tool changing unit are used. (example *ProtoMat* 95s, H100 and so on). If you now open the **TOOL** list field on the function bar, only the thirty or seven tool positions with their corresponding tool assignment are displayed instead of a list of all tools as for circuit board plotters with manual tool change.

Fig 55: Tool position

Tool Positions					
Pos. Tool	Select	Current [mm]	Maximum [mm]	New	Wanted for current job (phase)
1. Micro Cutter 0.1 mm (4 mil)	• C	25494	6000		
2. Universal Cutter 0.2 mm (8 mil)	- C	90222	50000		
3. End Mill 1.0 mm (39 mil)	- C	48333	20000		
4. Spiral Drill 0.5 mm	- C	5	3000	Γ	
5. Spiral Drill 0.2 mm	• C	690	1500		
6. Spiral Drill 1.0 mm	• 0	12	4000		
7. Contour Router 1.0 mm (39 mil)	• C	3529	7000		
8. Spiral Drill 2.0 mm	• C	17	2000	Г	
9. Spiral Drill 1.0 mm	• 0	32	4000		
10. Contour Router 2.0 mm (79 mil)	• C	1501	8000	Γ	
			Pg <u>U</u> p	1	C Up C Down
OK Cancel			Pg <u>D</u> n		Stop at tool exchange



Note: When the program is started for the first time, the tool <UNKNOWN> is assigned to each tool position, i.e. no tool entered. This is intended to cause the user to check the tools in the circuit board plotter magazines and assign the corresponding positions in the TOOL POSITIONS dialog box.

It is absolutely necessary to ensure that the tools in the tool box coincide exactly with those assigned in *BoardMaster* in order to prevent using the wrong tools and therefore malfunctions.

Open the **TOOL POSITIONS** dialog box by clicking the TOOL list field with the right-mouse button.

A tool can be assigned to the tool positions 1 to 30 by selecting the tool required for the production phase from the appropriate list field.

If a tool position is not assigned to a required tool, this dialog box is opened automatically when the production phase is started. It is possible to continue only after all tools have been assigned a position! The tools required for the selected production phase are listed in the list field **WANTED FOR CURRENT JOB** (PHASE).

The option **SELECT** indicates the tool momentarily located in the machining head.

The **CURRENT** life cycle and the **MAXIMUM** life cycle are indicated following each tool.

It is necessary for the **NEW** check box to be switched on when a used tool is replaced by a new tool in the tool box. The current life cycle is then reset to 0.

When exiting *BoardMaster*, the tool assignment in *BoardMaster* are stored under the name extension *.TLS and automatically reloaded each time *BoardMaster* is started.

4.3 Switch off

When switching off the circuit board plotter, first quit *BoardMaster* before switching off the machine. In the opposite sequence, recurring error messages are possible, which can be cancelled only by repeatedly actuating the **Yes** button. (Error message: Do you really want to cancel the current process...)

Before *BoardMaster* is actually switched off, a menu is displayed asking where the machining head is to be displaced to:

Fig 56: Go to reference point menu

Board M	laster 🛛 🕅
♪	Machine's head will move to reference point when you press the button !
	Ja Nein

Click on YES to move the drill/mill head to the reference point, respectively move to zero position.



4.4 Home position and reference hole system

The **HOME** position is a reference point programmed in the software. *BoardMaster* use this point as a reference position for orientation on the machine base plate. The circuit board plotter can be controlled correctly by *BoardMaster* only when this point is adjusted correctly. The **HOME** position must be located on the reflection axis (reference hole system) of the machine for production of circuit boards coated on both sides. The base material is turned around this reflection axis. Inaccuracies in the **HOME** position lead to an offset in processing the base material after turning.



Note: The HOME position is set at the factory and its position for a *ProtoMat* S62 is different from the position of the rest of the *ProtoMat* types.



Note: The parallelism of the reference hole system is ensured only for the current position of the reference hole strips. The front reference hole strip must be pushed against the reference pin in the reference hole groove (referenced). If you use base material of different sizes later, it will be necessary to drill an additional reference hole in the !rear! reference hole strip for each format. The position of the pusher for the various holes should be noted or marked on the circuit board plotter. This ensures parallelism for the various formats and eliminates the possibility of mix-ups.

It is only necessary to reprogram the **HOME** position in exceptional cases (offset on double-sided circuit boards) or possibly after transport of the machine or loss of the individual .INI file.





1- HOME position

2- Reference hole notch

3- PAUSE position





4.5 Camera functions



Note: Only for ProtoMat S62/100 with camera option.

Set Focus

Use the arrow keys to move the dril/mill head with camera until the image is focussed. Then press this key to have the current Z value stored in the INI file as focus position.

Focus

Click this button to have the camera moved back to the focus position when it the camera or drill/mill head is currently in a different position.

Stop Click this button stops ongoing reading processes of the camera, e.g. when fiducials are being read in.



4.6 2.5D mode

By activating the 2.5-D-Mode checkbox in the function bar the following dialog box will be opened:

Fig 59: 2.5-D-Mode dialog box

Board Master	
Is the working depth-limiter removed an	d the brush head mounted ?
ОК АЬЬ	orechen

In 2.5-D-Mode the working depth limiter is of no use, instead you should mount a brush. If the dialog is terminated with escape then the whole process is cancelled. By clicking **OK** the following dialog box will be opened:

Fig 60: 2.5-D-Mode

2.5D Mode	Complete penetration o Z-axis feed pe Numbe Material th	Lepth (H) 0 mm Through cutting er run (h) 0 mm r of runs 0 hickness 1.6 Accept
	Order of tools	Ref. materialhigh

The material thickness is divided into various processing layers. The number of layers depends on the depth with which the tool penetrates the material. The penetration depth must be individually adapted to each tool. The settings that are made can be stored in the job.

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Fig 61: Camera view

4.7 Camera image fiducial detection



Note: Only for *ProtoMat* S62/100 with camera option.





Note: This image can only be seen when the phase for fiducial recognition is selected.

When the camera is successfully calibrated, a live image like the figure above can be seen.

Freeze image

The image is "frozen" and the menu item **LIVE** becomes visible, so that it is possible to switch between the two modes.

Live image

The image is again represented in real time and the menu item **FREEZE** becomes visible. Thus it is possible to switch between the two modes.

Find

When the menu item **FIND** is activated, a standard fiducial is searched in the image area. The result is shown in a message as quality and stance to the image center.

Settings

After activation of this menu item the following dialog is opened:



Fig 62: Camera settings

Calibrate camera Overlay settings Brightness Change color Refresh overlay Outer support circle : 1.5 mm Middle support circle : 0.5 mm Contrast Cross-bair off	Fiducial set	tings Fiducial diameter: 1.5 fiducials in image area: 1 Minimal diameter [mm]: 1 Minimal quality [%]: 80 Default Accept	Image information QL_LIB version: 3.01.11 Size in [pixel]: 640 × 480 Size in [mm]: 4.37 × 3.28 Contrast : 43 Brightness : 18
	Brightness	Calibrate camera	Overlay settings Change color Refresh overlay Outer support circle : 1.5 mm Middle support circle : 1 mm Inner support circle : 0.5 mm Cross-hair off

Fiducial setting Changing the settings for fiducial detection.

Standard

Use default settings.

Transfer

Use actual edit settings.

Camera calibration

Camera adjustment with selected values.

Brightness

Adjust the camera brightness.

Contrast

Adjust the camera contrast.

Image information

Display of the actual camera settings.

Overlay settings

Changing the colour, switch ON/OFF the crosslines and changing the dimensions of the substitute circles.



Note: A detailed describtion of the camera calibration will be find in the machine manual (ProtoMat S62 or ProtoMat S100).



5 Troubleshooting

We refere to the particular machine manuals, for example user manual *ProtoMat* S62, to get detailed troubleshooting information.

The following informations are notes and tips and the first steps for troubleshooting when the system run out of function.

5.1 Circuit board plotter initialisation



<u>Danger!</u> The following instructions starts the circuit board plotter motor!

Take care that no person be in the process area of the circuit board plotter-Risk of crush!

Adhere the safety instruction of the machine manual!

- > Click on **CONFIGURATION>SETTINGS**.
- Click on UNLOCK (password protected) to change the machine parameter.
- > Click on INITIALIZE to start the initialisation process.

During the initialization process, the machining head moves to the limit switches in all four directions of motion, thereby transmitting the values measured to *BoardMaster*. These values are displayed in the text fields **ZERO POINT** (Xmin/Ymin, always 0/0) and **SIZE** (Xmax/Ymax). These entries cannot be edited, they can only be reset by initializing.

The values in the text field **PAUSE** are identical to the values in the text field **SIZE**. However, they can be edited to move the Pause position to any desired position.



Note: The values in the text field HOME (data origin) are set to Xmin and Ymax/2 as default. The HOME values determined in this manner are not the exact values leading to coincidence of the top and bottom during production of double-sided circuit boards. For this purpose, it is necessary for the HOME position to be located precisely on the plotter reflection axis.

To reset the **HOME** position precisely on the circuit board plotter reflection axis, it is necessary to drill new reference holes. For this purpose, first remove the base material and drilling panel as well as the reference hole pins. If no more space is present on the old reference hole strips, use new strips.



Then follow the following instructions:

After the circuit board plotter has come to a stop at the tool change position after initialization, select Spiral Drill Ref. 2.95 from the Tool list and clamp it in so that an interval of 0.5 mm is present between the base plate and tip of the drill (a 0.5 mm thick plate can be placed beneath as an aid).

The machine moves to the tool change position and the message "Continue after tool change" appears".

After inserting the tool acknowledge the message with **OK**.

- Move the machining head to the HOME position defined by initialization by clicking Go to in the menu and then HOME position.
- Move the machining head in the positive X direction with the arrow keys (not in Y direction under any circumstances) approx. 15 mm.
- Move the machining head with the arrow keys to the middle of the front reference hole strip (this time X and Y axes). For this purpose, set the increment to 0.05 mm.
- Move in the positive X direction to find a free point on the reference hole strip (if necessary, change increment setting).
- > Click on 🥙 to switch on the motor of the drill/mill head. Click on

to drill a hole. Wait until the drill/mill head has lowered com-

pletely into the material and click on again to lift the drill/mill head.

- > Click on **U** to switch off the motor of the drill/mill head.
- Move the drill/mill head 30 mm in the positive X direction from the new reference hole (not in Y direction under any circumstance), because the **HOME** position should always be 30 mm away from the reference hole.
- Go to CONFIGURATION>SETTINGS on the menu bar. Click on UNLOCK and then SETHOME. The data for the current machining head position are read in as the new HOME position and can be saved by clicking the OK button.
- Move the drill/mill head along the X axis to the rear reference hole strip and then drill the rear hole as described above by performing the concrete steps for drilling a hole (do not change anything in the menu Configuration again).

We recommend noting the values for the **HOME** position to prevent having to setup the circuit board plotter again if they are changed by mistake. However, after a new initialization run, it is always necessary to readjust the **HOME** position.



6 Appendix

6.1 From pen plotter to circuit board plotter

Conventional pen plotters, such as are used for printout of large graphics and drawings, have a paper transport for moving the paper back and forth along one axis (X axis). The print head containing various pins of different sizes and colors, can be moved along the second axis (Y axis). The print head can therefore be moved to any position on the paper. The print head is then lowered while the head/paper is moving so that the plotter can draw. It must be possible for the plotter to change the pins in order to draw lines of different thicknesses and colors.

The circuit board plotter operates according to the same principle with a few differences:

The base material, here the copper-coated circuit board material, is not transported; it is held tightly on a machine base plate. Instead of drawing, milling and drilling operations are accomplished. Some terms used in the *BoardMaster* software may be irritating because they are taken over from the old pen plotter technology.

For this reason, we have listed the basic terms in a comparative list for better understanding:

Pen Plotter	Circuit Board Plotter
Pen (thick, thin, black, red)	Tools (drill, milling cutter,)
Drawing paper as processing material	Circuit board base material as processing material
Pen change (thick, thin,)	Tool change (universal cutter, end mills,)



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